

Title (en)

Reception device for a backplane

Title (de)

Vorrichtung zur Aufnahme einer Rückwandleiterplatte

Title (fr)

Dispositif de réception pour un circuit imprimé

Publication

EP 1261077 B1 20080611 (DE)

Application

EP 02006872 A 20020326

Priority

DE 10124814 A 20010521

Abstract (en)

[origin: EP1261077A2] The arrangement has a contact arrangement for making contact between the circuit board (16) and the housing for units containing electronic and/or electrical units. The contact arrangement is in the form of sprung contact elements protruding in the direction of a screened surface of the circuit board. The contact elements (17) are arranged on a contact side of the arrangement facing the screened board surface.

IPC 8 full level

H01R 13/648 (2006.01); **H01R 13/658** (2006.01)

CPC (source: EP)

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DOCDB simple family (publication)

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